

# IRG4PSC71KD

INSULATED GATE BIPOLAR TRANSISTOR WITH  
ULTRAFAST SOFT RECOVERY DIODE

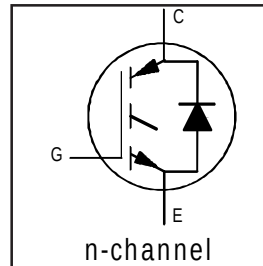
Short Circuit Rated  
UltraFast IGBT

## Features

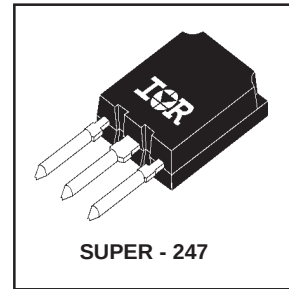
- Hole-less clip/pressure mount package compatible with TO-247 and TO-264, with reinforced pins
- High abort circuit rating IGBTs, optimized for motorcontrol
- Minimum switching losses combined with low conduction losses
- Tightest parameter distribution
- IGBT co-packaged with ultrafast soft recovery antiparallel diode
- Creepage distance increased to 5.35mm

## Benefits

- Highest current rating copack IGBT
- Maximum power density, twice the power handling of the TO-247, less space than TO-264
- HEXFRED™ diode optimized for operation with IGBT, to minimize EMI, noise and switching losses



$V_{CES} = 600V$   
 $V_{CE(on)} \text{ typ.} = 1.83V$   
@  $V_{GE} = 15V, I_C = 60A$



## Absolute Maximum Ratings

|                           | Parameter                          | Max.                              | Units      |
|---------------------------|------------------------------------|-----------------------------------|------------|
| $V_{CES}$                 | Collector-to-Emitter Voltage       | 600                               | V          |
| $I_C @ T_C = 25^\circ C$  | Continuous Collector Current       | 85 ⑤                              | A          |
| $I_C @ T_C = 100^\circ C$ | Continuous Collector Current       | 60                                |            |
| $I_{CM}$                  | Pulsed Collector Current ①         | 200                               |            |
| $I_{LM}$                  | Clamped Inductive Load Current ②   | 200                               |            |
| $I_F @ T_C = 100^\circ C$ | Diode Continuous Forward Current   | 50                                |            |
| $I_{FM}$                  | Diode Maximum Forward Current      | 200                               |            |
| $t_{SC}$                  | Short Circuit Withstand Time       | 10                                | $\mu s$    |
| $V_{GE}$                  | Gate-to-Emitter Voltage            | $\pm 20$                          | V          |
| $P_D @ T_C = 25^\circ C$  | Maximum Power Dissipation          | 350                               | W          |
| $P_D @ T_C = 100^\circ C$ | Maximum Power Dissipation          | 140                               |            |
| $T_J$                     | Operating Junction and             | -55 to +150                       | $^\circ C$ |
| $T_{STG}$                 | Storage Temperature Range          |                                   |            |
|                           | Soldering Temperature, for 10 sec. | 300 (0.063 in. (1.6mm) from case) |            |

## Thermal Resistance Mechanical

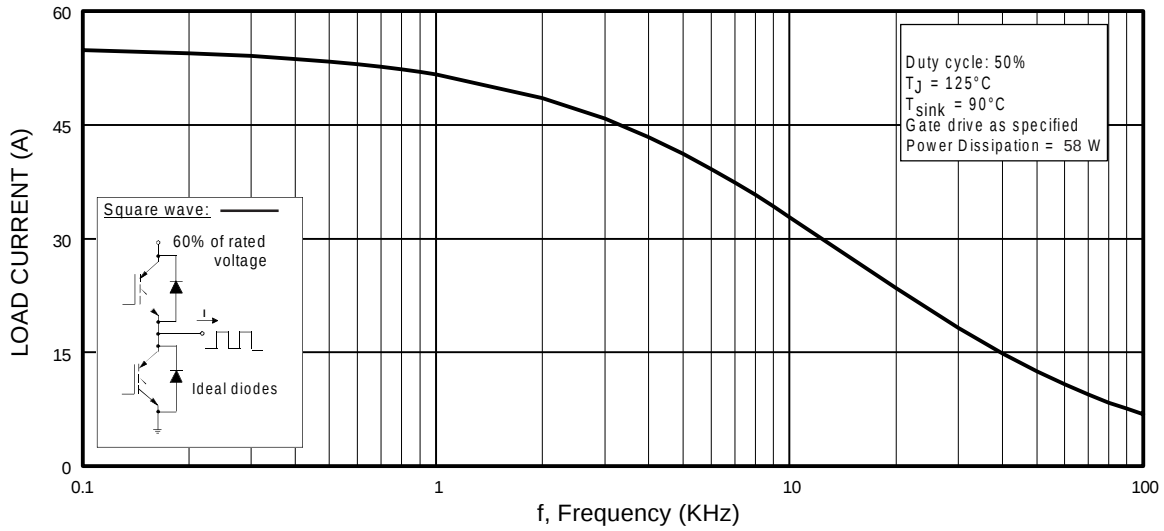
|                 | Parameter                                 | Min.      | Typ.     | Max. | Units        |
|-----------------|-------------------------------------------|-----------|----------|------|--------------|
| $R_{\theta JC}$ | Junction-to-Case - IGBT                   | —         | —        | 0.36 | $^\circ C/W$ |
| $R_{\theta JC}$ | Junction-to-Case - Diode                  | —         | —        | 0.69 |              |
| $R_{\theta CS}$ | Case-to-Sink, flat, greased surface       | —         | 0.24     | —    |              |
| $R_{\theta JA}$ | Junction-to-Ambient, typical socket mount | —         | —        | 38   |              |
|                 | Recommended Clip Force                    | 20.0(2.0) | —        | —    | N (kgf)      |
|                 | Weight                                    | —         | 6 (0.21) | —    | g (oz)       |

**Electrical Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

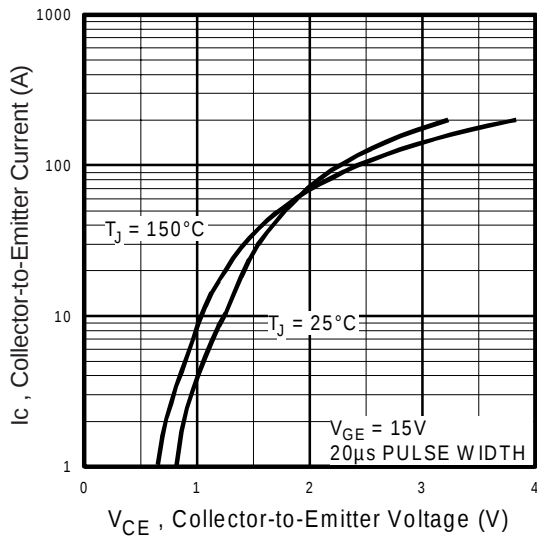
|                                 | Parameter                                           | Min. | Typ. | Max.      | Units                | Conditions                                            |
|---------------------------------|-----------------------------------------------------|------|------|-----------|----------------------|-------------------------------------------------------|
| $V_{(BR)CES}$                   | Collector-to-Emitter Breakdown Voltage <sup>③</sup> | 600  | —    | —         | V                    | $V_{GE} = 0V, I_C = 250\mu A$                         |
| $\Delta V_{(BR)CES}/\Delta T_J$ | Temperature Coeff. of Breakdown Voltage             | —    | 0.5  | —         | V/ $^\circ\text{C}$  | $V_{GE} = 0V, I_C = 10mA$                             |
| $V_{CE(on)}$                    | Collector-to-Emitter Saturation Voltage             | —    | 1.83 | 2.3       | V                    | $I_C = 60A, V_{GE} = 15V$                             |
|                                 |                                                     | —    | 2.20 | —         |                      | $I_C = 100A$                                          |
|                                 |                                                     | —    | 1.81 | —         |                      | $I_C = 60A, T_J = 150^\circ\text{C}$                  |
| $V_{GE(th)}$                    | Gate Threshold Voltage                              | 3.0  | —    | 6.0       |                      | $V_{CE} = V_{GE}, I_C = 250\mu A$                     |
| $\Delta V_{GE(th)}/\Delta T_J$  | Temperature Coeff. of Threshold Voltage             | —    | -8.0 | —         | mV/ $^\circ\text{C}$ | $V_{CE} = V_{GE}, I_C = 1.5mA$                        |
| $g_{fe}$                        | Forward Transconductance <sup>④</sup>               | 31   | 46   | —         | S                    | $V_{CE} = 50V, I_C = 60A$                             |
| $I_{CES}$                       | Zero Gate Voltage Collector Current                 | —    | —    | 500       | $\mu A$              | $V_{GE} = 0V, V_{CE} = 600V$                          |
|                                 |                                                     | —    | —    | 13        | mA                   | $V_{GE} = 0V, V_{CE} = 600V, T_J = 150^\circ\text{C}$ |
| $V_{FM}$                        | Diode Forward Voltage Drop                          | —    | 1.4  | 1.7       | V                    | $I_C = 60A$                                           |
|                                 |                                                     | —    | 1.3  | —         |                      | $I_C = 60A, T_J = 150^\circ\text{C}$                  |
| $I_{GES}$                       | Gate-to-Emitter Leakage Current                     | —    | —    | $\pm 100$ | nA                   | $V_{GE} = \pm 20V$                                    |

**Switching Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

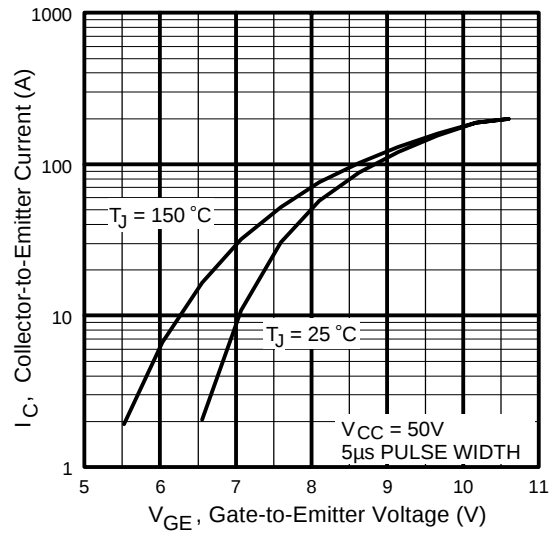
|                  | Parameter                                        | Min. | Typ. | Max. | Units      | Conditions                                              |
|------------------|--------------------------------------------------|------|------|------|------------|---------------------------------------------------------|
| $Q_g$            | Total Gate Charge (turn-on)                      | —    | 340  | 510  | nC         | $I_C = 60A$                                             |
| $Q_{ge}$         | Gate - Emitter Charge (turn-on)                  | —    | 44   | 66   |            | $V_{CC} = 400V$                                         |
| $Q_{gc}$         | Gate - Collector Charge (turn-on)                | —    | 160  | 240  |            | $V_{GE} = 15V$                                          |
| $t_{d(on)}$      | Turn-On Delay Time                               | —    | 82   | —    | ns         | $T_J = 25^\circ\text{C}$                                |
| $t_r$            | Rise Time                                        | —    | 107  | —    |            | $I_C = 60A, V_{CC} = 480V$                              |
| $t_{d(off)}$     | Turn-Off Delay Time                              | —    | 282  | 423  |            | $V_{GE} = 15V, R_G = 5.0\Omega$                         |
| $t_f$            | Fall Time                                        | —    | 97   | 146  | mJ         | Energy losses include "tail" and diode reverse recovery |
| $E_{on}$         | Turn-On Switching Loss                           | —    | 3.95 | —    |            | See Fig. 9,10,18                                        |
| $E_{off}$        | Turn-Off Switching Loss                          | —    | 2.33 | —    |            |                                                         |
| $E_{ts}$         | Total Switching Loss                             | —    | 6.28 | 7.7  | $\mu s$    | $V_{CC} = 360V, T_J = 125^\circ\text{C}$                |
| $t_{sc}$         | Short Circuit Withstand Time                     | 10   | —    | —    |            | $V_{GE} = 15V, R_G = 5.0\Omega, V_{CPK} < 500V$         |
| $t_{d(on)}$      | Turn-On Delay Time                               | —    | 87   | —    | ns         | $T_J = 150^\circ\text{C},$                              |
| $t_r$            | Rise Time                                        | —    | 104  | —    |            | See Fig. 11,18                                          |
| $t_{d(off)}$     | Turn-Off Delay Time                              | —    | 374  | —    |            | $I_C = 60A, V_{CC} = 480V$                              |
| $t_f$            | Fall Time                                        | —    | 143  | —    | mJ         | $V_{GE} = 15V, R_G = 5.0\Omega$                         |
| $E_{ts}$         | Total Switching Loss                             | —    | 8.5  | —    |            | Energy losses include "tail" and diode reverse recovery |
| $L_E$            | Internal Emitter Inductance                      | —    | 13   | —    | nH         | Measured 5mm from package                               |
| $C_{ies}$        | Input Capacitance                                | —    | 6900 | —    | pF         | $V_{GE} = 0V$                                           |
| $C_{oes}$        | Output Capacitance                               | —    | 730  | —    |            | $V_{CC} = 30V$                                          |
| $C_{res}$        | Reverse Transfer Capacitance                     | —    | 190  | —    |            | $f = 1.0MHz$                                            |
| $t_{rr}$         | Diode Reverse Recovery Time                      | —    | 82   | 120  | ns         | $T_J = 25^\circ\text{C}$ See Fig. 14                    |
|                  |                                                  | —    | 140  | 210  |            | $T_J = 125^\circ\text{C}$                               |
| $I_{rr}$         | Diode Peak Reverse Recovery Current              | —    | 8.2  | 12   | A          | $T_J = 25^\circ\text{C}$ See Fig. 15                    |
|                  |                                                  | —    | 13   | 20   |            | $T_J = 125^\circ\text{C}$                               |
| $Q_{rr}$         | Diode Reverse Recovery Charge                    | —    | 364  | 546  | nC         | $T_J = 25^\circ\text{C}$ See Fig. 16                    |
|                  |                                                  | —    | 1084 | 1625 |            | $T_J = 125^\circ\text{C}$                               |
| $di_{(rec)M}/dt$ | Diode Peak Rate of Fall of Recovery During $t_b$ | —    | 328  | —    | A/ $\mu s$ | $T_J = 25^\circ\text{C}$ See Fig. 17                    |
|                  |                                                  | —    | 266  | —    |            | $T_J = 125^\circ\text{C}$                               |



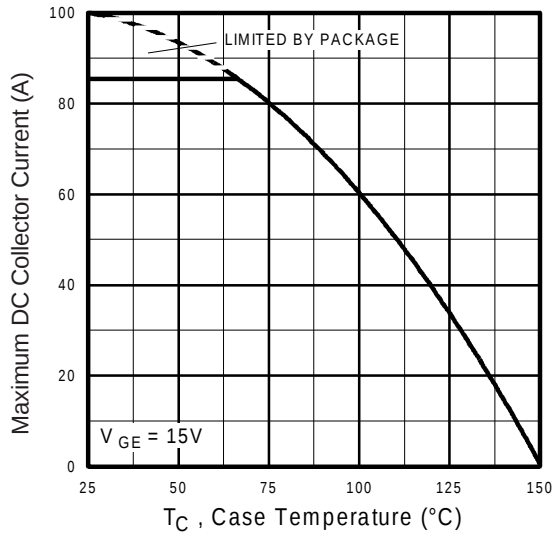
**Fig. 1** - Typical Load Current vs. Frequency  
(Load Current =  $I_{RMS}$  of fundamental)



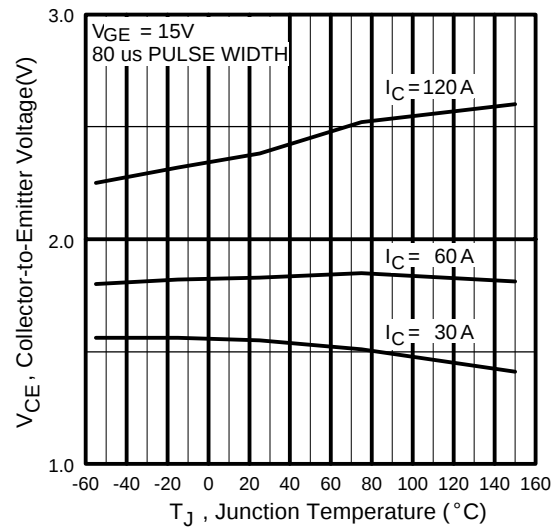
**Fig. 2** - Typical Output Characteristics



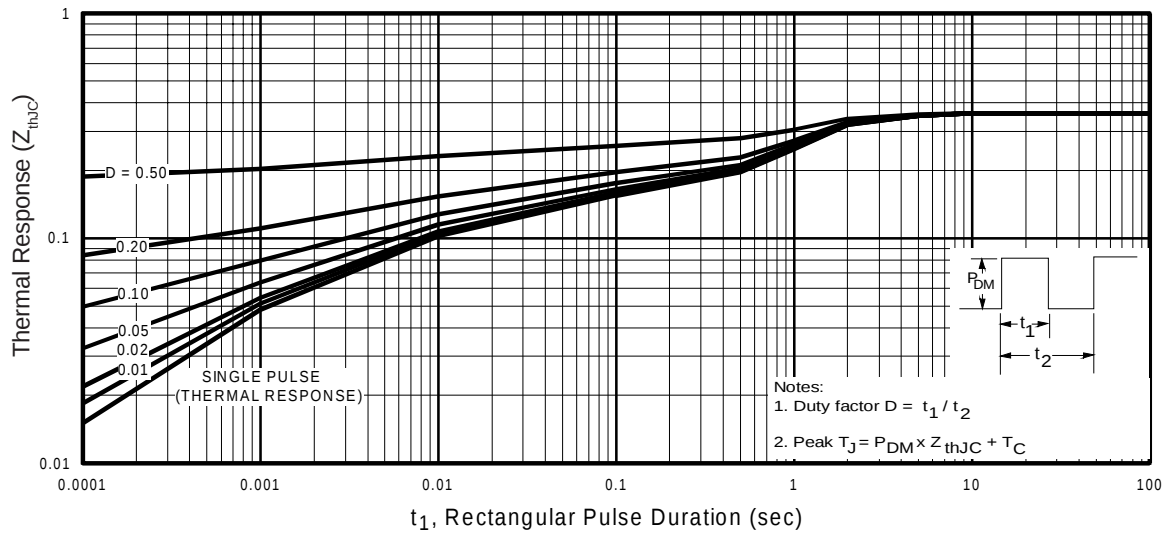
**Fig. 3** - Typical Transfer Characteristics



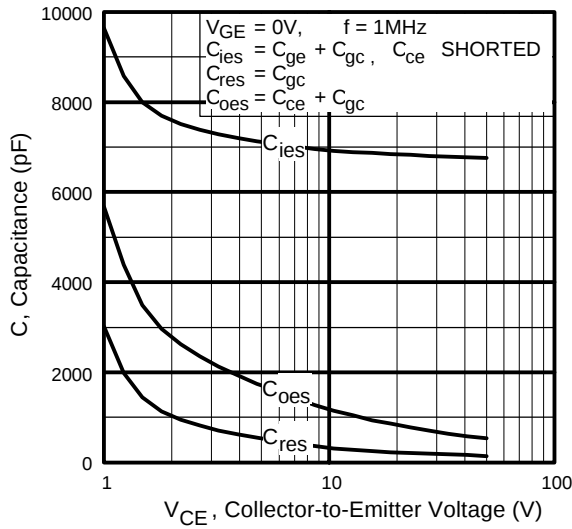
**Fig. 4** - Maximum Collector Current vs. Case Temperature



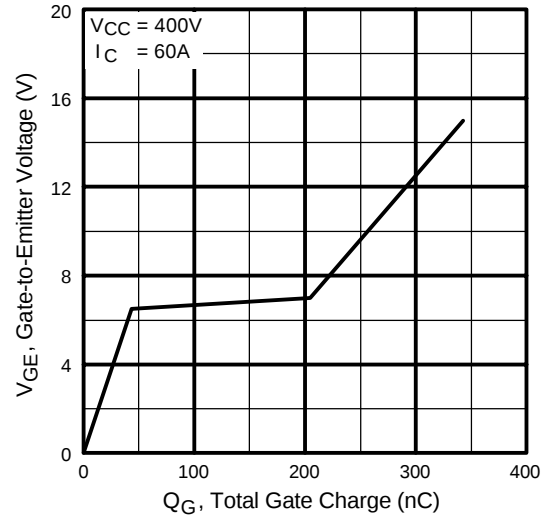
**Fig. 5** - Typical Collector-to-Emitter Voltage vs. Junction Temperature



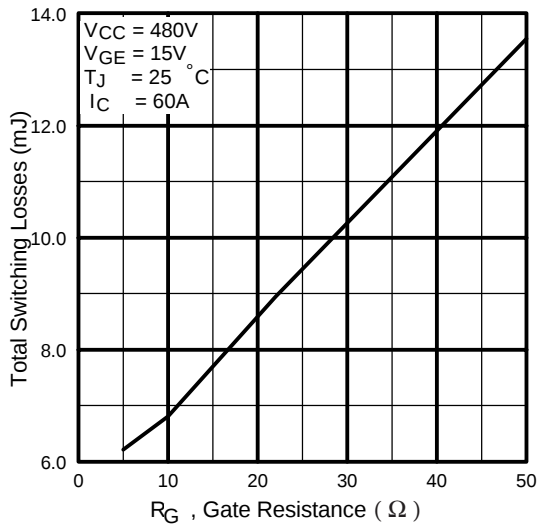
**Fig. 6** - Maximum Effective Transient Thermal Impedance, Junction-to-Case



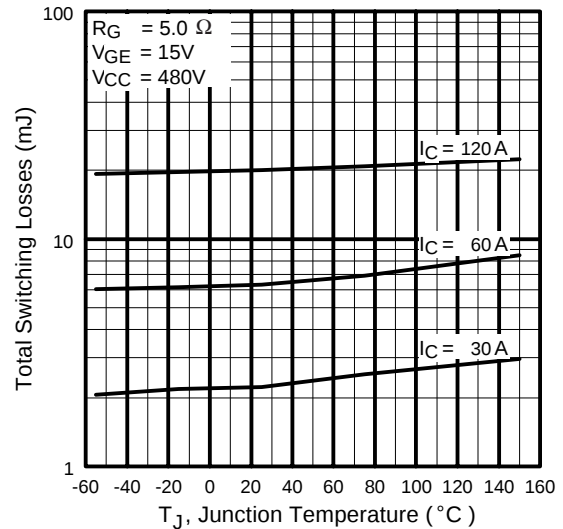
**Fig. 7** - Typical Capacitance vs. Collector-to-Emitter Voltage



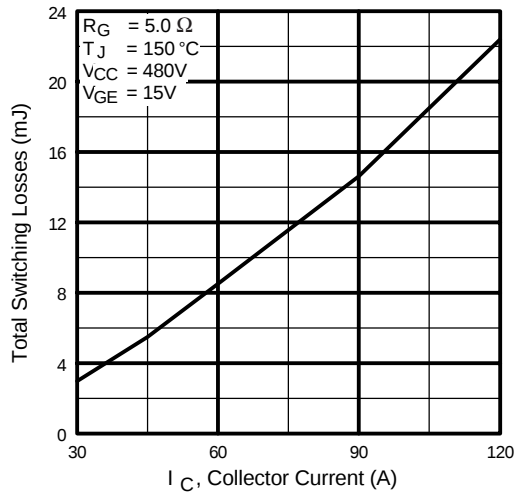
**Fig. 8** - Typical Gate Charge vs. Gate-to-Emitter Voltage



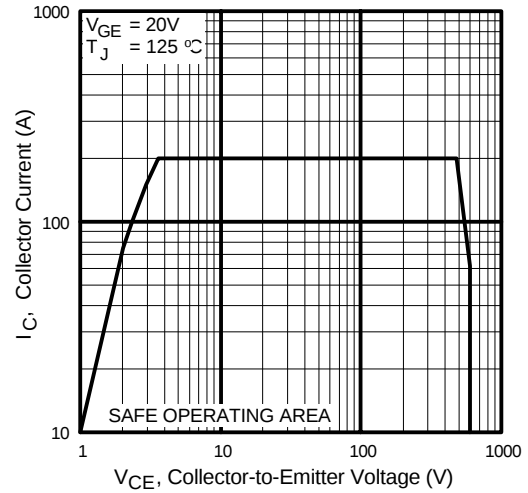
**Fig. 9** - Typical Switching Losses vs. Gate Resistance



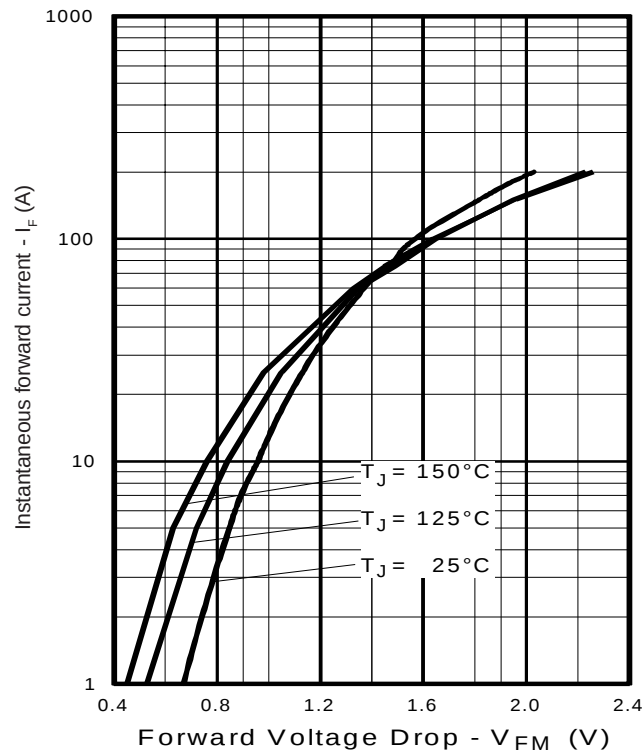
**Fig. 10** - Typical Switching Losses vs. Junction Temperature



**Fig. 11** - Typical Switching Losses vs. Collector-to-Emitter Current



**Fig. 12** - Turn-Off SOA



**Fig. 13** - Maximum Forward Voltage Drop vs. Instantaneous Forward Current

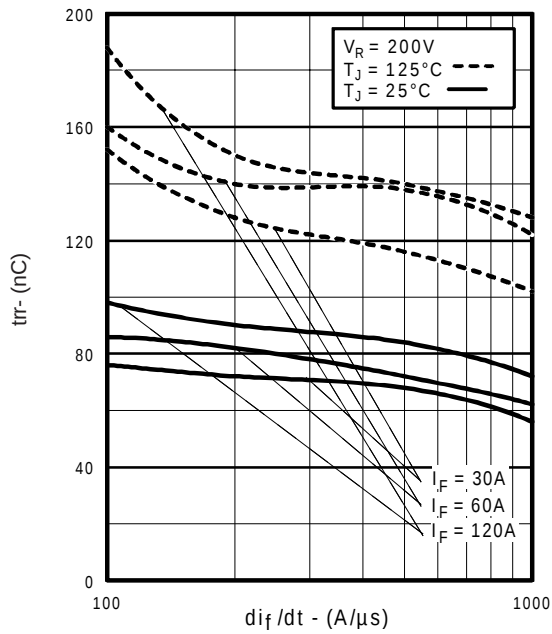


Fig. 14 - Typical Reverse Recovery vs.  $di/dt$

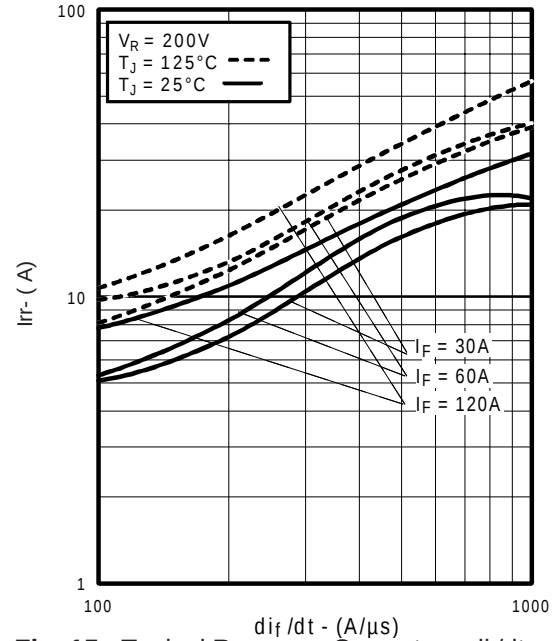


Fig. 15 - Typical Recovery Current vs.  $di/dt$

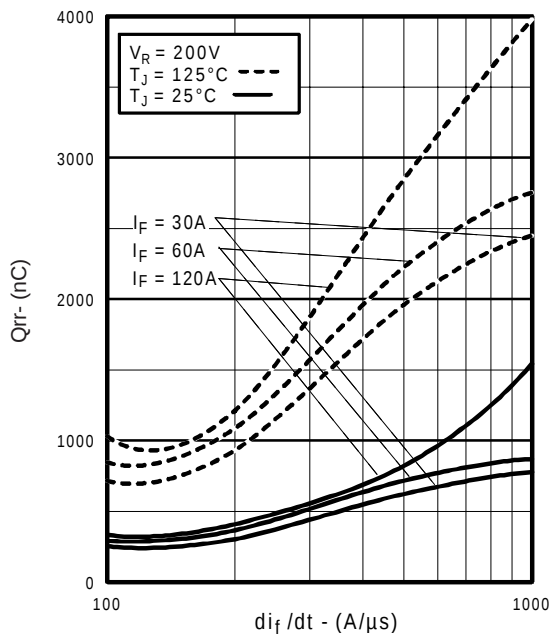


Fig. 16 - Typical Stored Charge vs.  $di/dt$   
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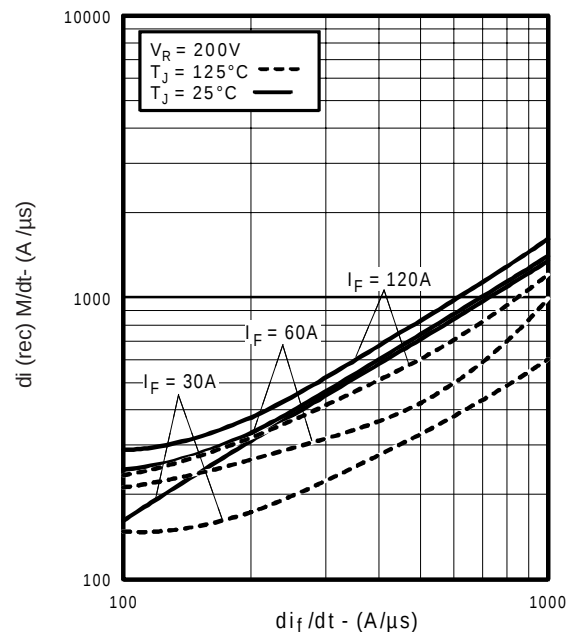
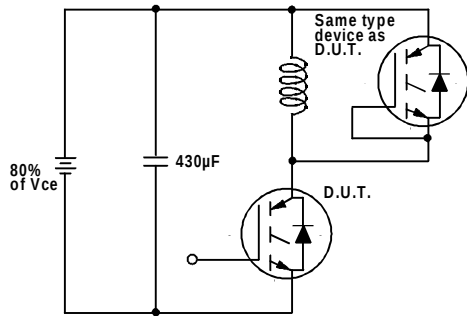
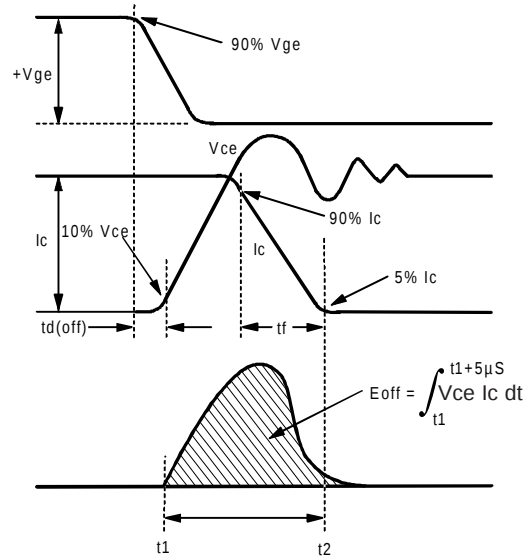


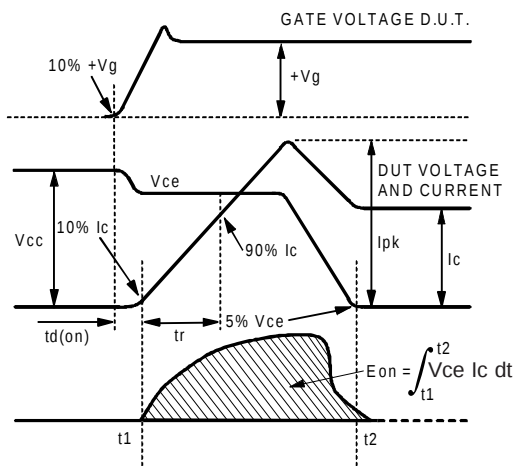
Fig. 17 - Typical  $di_{(rec)}M/dt$  vs.  $di/dt$



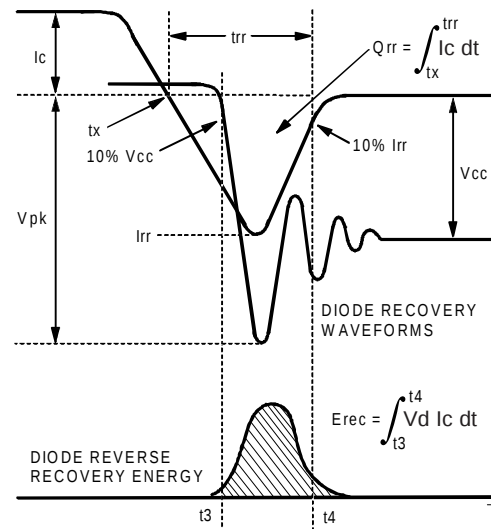
**Fig. 18a** - Test Circuit for Measurement of  $I_{LM}$ ,  $E_{on}$ ,  $E_{off}(\text{diode})$ ,  $t_{rr}$ ,  $Q_{rr}$ ,  $I_{rr}$ ,  $t_{d(on)}$ ,  $t_r$ ,  $t_{d(off)}$ ,  $t_f$



**Fig. 18b** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{off}$ ,  $t_{d(off)}$ ,  $t_f$



**Fig. 18c** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{on}$ ,  $t_{d(on)}$ ,  $t_r$



**Fig. 18d** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{rec}$ ,  $t_{rr}$ ,  $Q_{rr}$ ,  $I_{rr}$

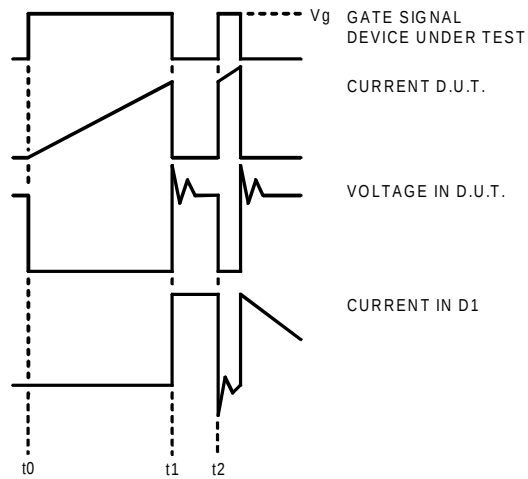


Figure 18e. Macro Waveforms for Figure 18a's Test Circuit

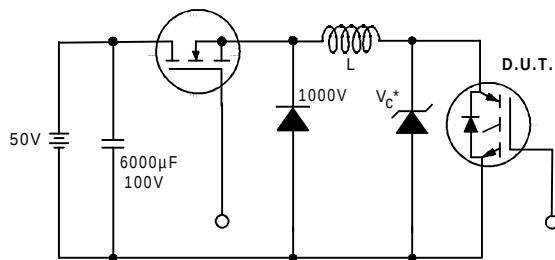


Figure 19. Clamped Inductive Load Test Circuit

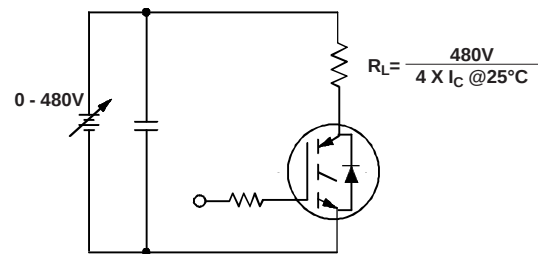


Figure 20. Pulsed Collector Current Test Circuit

## IRG4PSC71KD

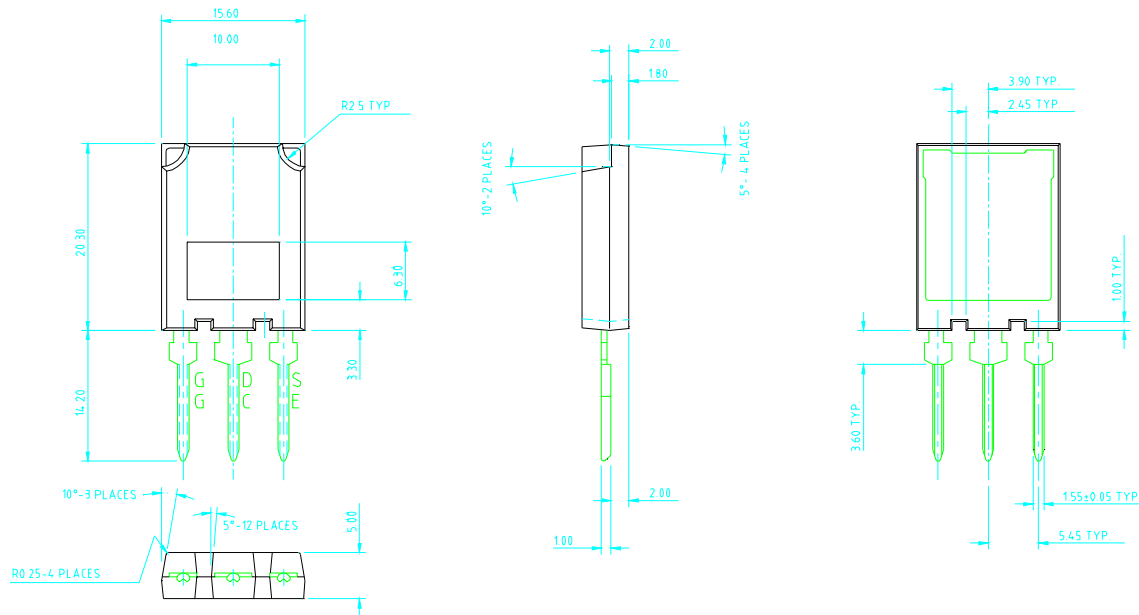
International  
**IR** Rectifier

### Notes:

- ① Repetitive rating:  $V_{GE}=20V$ ; pulse width limited by maximum junction temperature (figure 20)
- ②  $V_{CC}=80\%(V_{CES})$ ,  $V_{GE}=20V$ ,  $L=10\mu H$ ,  $R_G=5.0\Omega$  (figure 19)
- ③ Pulse width  $\leq 80\mu s$ ; duty factor  $\leq 0.1\%$
- ④ Pulse width  $5.0\mu s$ , single shot
- ⑤ Current limited by the package, (Die current = 100A)

## Case Outline and Dimensions — Super-247

Dimensions are shown in millimeters



International  
**IR** Rectifier

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